

SILICON TRANSISTORS

2SA1376, 1376A

PNP SILICON EPITAXIAL TRANSISTOR FOR HIGH VOLTAGE AMPLIFIERS

FEATURES

· High voltage

Vceo: -180 V / -200 V (2SA1376/2SA1376A)

- Excellent here linearity
- High total power dissipation in small dimension:
 PT: 0.75 W
- · Complementary transistor with 2SC3478 and 2SC3478A

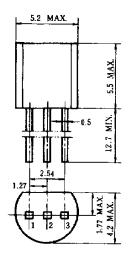
ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

2SA1376/2SA1376A

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	-200	V
Collector to emitter voltage	VCEO	-180/-200	V
Emitter to base voltage	VEBO	-5	V
Collector current (DC)	Ic(DC)	-100	mA
Collector current (pulse)	I _{C(pulse)} *	-200	mA
Total power dissipation	Р⊤	0.75	W
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

^{*} PW \leq 10 ms, duty cycle \leq 50%

PACKAGE DRAWING (UNIT: mm)



Electrode Connection

1. Emitter EIAJ : SC-43B 2. Collector JEDEC : TO-92 3. Base IEC : PA33

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

2SA1376/2SA1376A

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -200 \text{ V}, I_E = 0$			-100	nA
Emitter cutoff current	ІЕВО	$V_{EB} = -5 \text{ V}, I_{C} = 0$			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -10 \text{ V}, \text{ Ic} = -10 \text{ mA}$	135	300/200	600/400	
DC current gain	hFE2 **	$V_{CE} = -10 \text{ V}, \text{ Ic} = -100 \text{ mA}$	81			
DC base voltage	V _{BE} **	$V_{CE} = -10 \text{ V}, \text{ Ic} = -10 \text{ mA}$	-600	-650	-700	mV
Collector saturation voltage	V _{CE(sat)} **	Ic = -50 mA, IB = -5 mA		-0.2	-0.3	V
Base saturation voltage	V _{BE(sat)} **	Ic = -50 mA, IB = -5 mA		-0.8	-1.2	V
Output capacitance	Cob	$V_{CB} = -30 \text{ V}, I_E = 0, f = 1.0 \text{ MHz}$		3.5	4.0	pF
Gain bandwidth product	f⊤	$V_{CE} = -10 \text{ V}, I_E = 10 \text{ mA}$	80	120		MHz
Turn-on time	ton	$I_C = -10 \text{ mA}, I_{B1} = -I_{B2} = -1 \text{ mA},$		0.16		μs
Turn-off time	toff	$V_{CC} = -10 \text{ V}$		1.5		μs

^{**} Pulse test PW \leq 350 μ s, duty cycle \leq 2% per pulsed

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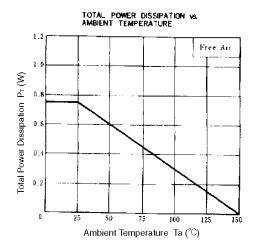
hfe CLASSIFICATION

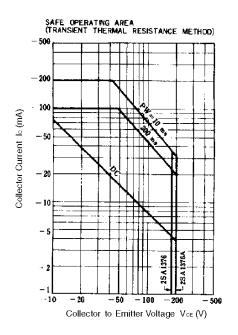
Marking	L	К	U
h _{FE1}	135 to 270	200 to 400	300 to 600

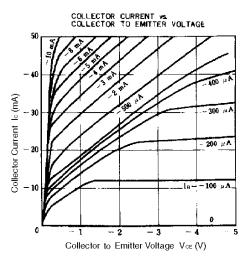
(The U rank is not available for the 2SA1376A.)

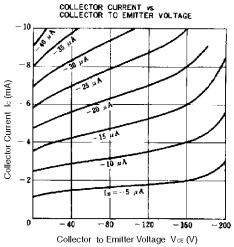


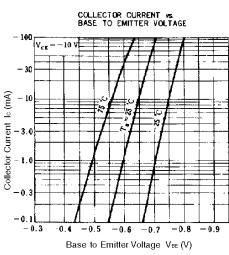
TYPICAL CHARACTERISTICS (Ta = 25°C)

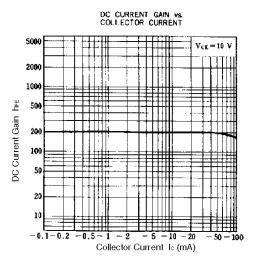


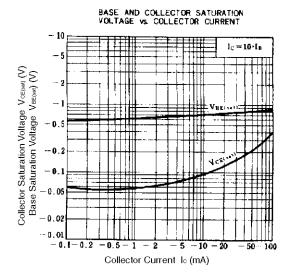


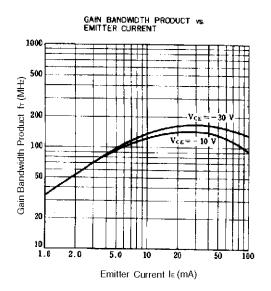


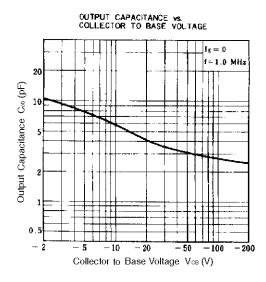


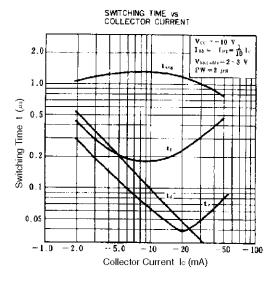
















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